T-51-09-16

## **Microprocessor-Compatible** 16-BIT DIGITAL-TO-ANALOG CONVERTERS

#### **FEATURES**

- TWO-CHIP CONSTRUCTION
- HIGH-SPEED 16-BIT PARALLEL, 8-BIT (BYTE) PARALLEL, AND SERIAL INPUT MODES
- DOUBLE-BUFFERED INPUT REGISTER CONFIGURATION
- . VOUT AND IOUT MODELS

### DESCRIPTION

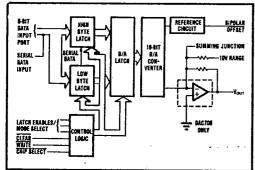
The DAC708 and DAC709 are 16-bit converters designed to interface to an 8-bit microprocessor bus. 16-bit data is loaded in two successive 8-bit bytes into parallel 8-bit latches before being transferred into the D/A latch. The DAC708 and DAC709 are current and voltage output models respectively and are in 24-pin hermetic DIPs. Input coding is Binary Two's Complement (bipolar) or Unipolar Straight Binary (unipolar, when an external logic inverter is used to invert the MSB). In addition, the DAC708/-709 can be loaded serially (MSB first).

The DAC705, DAC706, and DAC707 are designed to interface to a 16-bit bus. Data is written into a 16-bit latch and subsequently the D/A latch. The

- **HIGH ACCURACY:**
- Linearity Error ±0.003% of FSR max Differential Linearity Error ±0.006% of FSR max
- MONOTONIC (TO 14 BITS) OVER SPECIFIED TEMPERATURE RANGE
- HERMETICALLY SEALED
- LOW COST PLASTIC VERSIONS AVAILABLE (DAC707JP/KP)

DAC705 and DAC707 are voltage output models, DAC706 is a current output model. Outputs are bipolar only (current or voltage) and input coding is Binary Two's Complement (BTC).

All models have Write and Clear control lines as well as input latch enable lines. In addition, DAC708 and DAC709 have Chip Select control lines. In the bipolar mode, the Clear input sets the D/A latch to give zero voltage or current output. They are all 14-bit accurate and are complete with reference, and for the DAC705, DAC707, and DAC709, a voltage output amplifier. All models are available with an optional burn-in, or environmental screening.



DAC708/709 Block Diagram

DATA ( LATCH ENABLES

DAC705/706/707 Block Diagram

International Airport industrial Park - P.O. Box 11400 - Tucson, Arizona 85734 - Tel. (602) 746-1111 - Twx: 910-952-1111 - Cable: BBRCORP - Telex: 66-6491

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**NSTRUMENTATION D/A CONVERTERS** 

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## **SPECIFICATIONS**

**ELECTRICAL** At  $T_A = +25^{\circ}C$ ,  $V_{CO} = \pm 15V$ ,  $V_{DO} = +5V$ , and after a 10-minute warm-up unless otherwise noted.

MODEL	DAC705/706/707/708/709KH, DAC707KP DAC707KP					709BH, SH			7	
	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	UNITS
INPUT										· · · · · · · · · · · · · · · · · · ·
DIGITAL INPUT Resolution Bipolar Input Code (all models) Unipolar Input Code <sup>(1)</sup> (DAC708/709 only)	Binary	Two's Comp	16 Iement	Unipo	e lar Straight	* Binary		:	r is been	Bits
Logic Levels <sup>22</sup> : V <sub>IH</sub> V <sub>R</sub> I <sub>IH</sub> (V <sub>I</sub> = +2.7V) I <sub>IL</sub> (V <sub>I</sub> = +0.4V)	+2.0 -1.0		+5.5 +0.8 1 1	* * ";		•				V V μA μA
TRANSFER CHARACTERISTICS										
ACCURACY <sup>IS</sup> Linearity Error Differential Linearity Error <sup>IS</sup> at Bipolar Zero <sup>IS, &amp;I</sup> Gain Error <sup>IT</sup> Zero Error <sup>IT</sup> Monotonicity Over Spec Temp Range Power Supply Sensitivity: +Vcc, -Vcc Voo	13	±0.003 ±0.0045 ±0.07 ±0.05 ±0.0015 ±0.0001	±0.006 ±0.012 ±0.30 ±0.1 ±0.006 ±0.001	14	±0.0015 ±0.003 ±0.003	±0.003 ±0.006 ±0.008 ±0.15	14	±0.0015 ±0.05	±0.003 ±0.10 ±0.003	% of FSR <sup>14</sup> % of FSR % of FSR % f of FSR Bits % of FSR/%Vo
DRIFT (over Spec Temp rangel <sup>33</sup> ) Total Error over Temp Range <sup>39</sup> Total Full Scale Drift Gain Drift Zero Drift: Unipolar (DAC708/709 only) Bipolar (all models) Differential Linearity Over Temp <sup>(5)</sup> Linearity Error Over Temp <sup>(5)</sup>		±0.08 ±10 ±10	±30 ±15 ±0.012 ±0.012		±2.5	±0.15 ±25 ±25 ±5 ±12 +0.009, -0.006 ±0.006		* ±7 ±1.5 ±4	±0.10 ±15 ±15 ±3 ±10	% of FSR ppm of FSR/° ppm/°C ppm of FSR/° ppm of FSR/° % of FSR % of FSR
SETTLING TIME (to ±0.003% of FSR) <sup>(N)</sup>				<del>                                     </del>		· · · · ·		l		
Voltage Output Models Full Scale Step (2kΩ load) SLES Step at Worst Case Code <sup>tto</sup> SLEW Rate Current Output Models Full Scale Step (2mA): 10 to 100Ω load 1kΩ load		4 2.5 10			* * * 350	8 4	:	•	8 4	rs V/ps ns ns
OUTPUT										
VOLTAGE OUTPUT MODELS Output Voltage Range DAC709: Unipolar (USB Code) Bipolar (BTC Code) DAC707 Bipolar (BTC Code) DAC705 Bipolar (BTC Code) Output Current Output Impedance Short Circuit to Common Duration CURRENT OUTPUT MODELS	±5	±10 0.15 Indefinite		•	0 to +10 ±5, ±10 ±5					V V V mA Ω
Output Current Range (±30% typ) DAC708: Unipolar (USB Code) Bipolar (BTC Code) DAC706 Bipolar (BTC Code) Unipolar Output Impedance (±30% typ) Bipolar Output Impedance (±30% typ) Compliance Voltage					0 to2 ±1 ±1 4.0 2.45 ±2.5			:		mA mA mA kΩ kΩ
POWER SUPPLY REQUIREMENTS	1 140.5	1 140	140-	1 .	1 .	1.	<del>.</del>	T •	•	T v
Voltage (all models): +V∞ -V∞ Voo	+13.5 -13.5 +4.5	+15 -15 +5	+16.5 16.5 +5.5	:			:			v
Current (No load, +15V supplies) Current Output Models: +Vcc -Vcc Voo Voltage Ouplut Models: +Vcc		+16	+30		+10 -13 +5 *	+25 -25 +10				mA mA mA mA
V <sub>00</sub> V <sub>00</sub>		-18 +5	-30 +10	1	1:	<u> </u>	<u> </u>	<u> </u>	<u> </u>	mA

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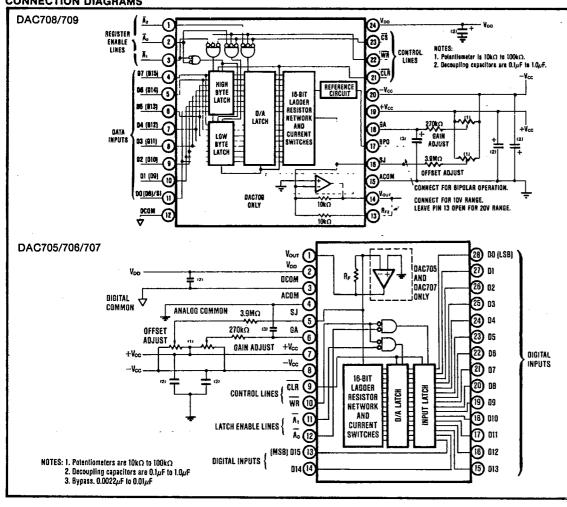
**ELECTRICAL (CONT)** 

MODEL		DAC707JP			DAC705/706/707/708/709KH, DAC707KP			DAC705/706/707/708/ 709BH, SH		
	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	UNITS
POWER SUPPLY REQUIREMENTS (CO	iT)									
Power Dissipation (±15V supplies) Current Output Models Voltage Output Models		535			370	800 950		1 - 1 - 1 - 1 - 1 - 1 - 1 - 1 - 1 - 1 -	:	mW mW
TEMPERATURE RANGE	<del></del>					·			<u> </u>	
Specification: BH grades JP, KP, KH grades SH grades Storage: Ceramic Plastic	0 -60		+70 +100	-65 •		+150	-25 -55 -65		+85 +125 +150	ວໍດໍດໍດໍດໍ

<sup>\*</sup>Specification same as for models in column to the left.

NOTES: (1) MSB must be inverted externally prior to DAC708/709 input. (2) Digital Inputs are TTL, LSTTL, 54/74C, 54/74HC and 54/74HTC compatible over the specified temperature range. (3) DAC706 and DAC708 (current-output models) are specified and tested with an external output operational amplifier connected using the internal feedback resistor in all tests. (4) FSR means Full Scale Range. For example, for ±10V output, FSR = 20V. (5) ±0.0015% of Full Scale Range is equal to 1 LSB in 16-bit resolution. ±0.006% of Full Scale Range is equal to 1 LSB in 16-bit resolution. ±0.006% of Full Scale Range is equal to 1 LSB in 16-bit resolution. ±0.006% of Full Scale Range is equal to 1 LSB in 16-bit resolution. (8) Error at input code 00004. (For unipolar connection on DAC708/709, the MSB must be inverted externally prior to D/A input.) (7) Adjustable to zero with external trim potentiometer. Adjusting the gain potentiometer rotates the transfer function around the bipolar zero point. (8) With gain and zero errors adjusted to zero at +25°CC. (9) Maximum represents the 3*c* limit. Not 100% tested for this parameter. (10) The bipolar worst-case code change is FFFF<sub>H</sub> to 0000<sub>H</sub> and 0000<sub>H</sub> to FFFF<sub>H</sub>.

#### **CONNECTION DIAGRAMS**



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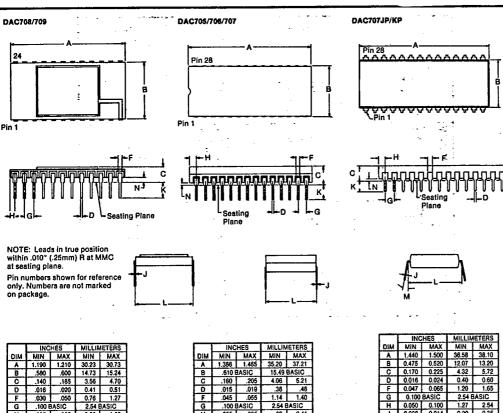
**NSTRUMENTATION D/A CONVERTERS** 

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## DESCRIPTION OF PIN FUNCTIONS

	DAC705/706/707	Pin		DAC708/709
Designator	Description	#	Designator	Description
Vour (DAC707 and DAC705) R <sub>F</sub> (DAC706)	Voltage output for DAC707 (±10V) and DAC705 (±5V) or an internal feedback resistor for use with an external output op amp for the DAC708.	1	Az	Latch enable for D/A latch (Active low)
Voo	Logic supply (+5V)	2	Aq :	Latch enable for "low byte" input (Active low). When both $A_0$ and $A_1$ are logic "0", the serial input mode is selected and the serial input is enabled.
рсом	Digital common	3	Aı	Latch enable for "high byte" input (Active low). When both Ao and A <sub>1</sub> are logic "0", the serial input mode is selected and the serial input is enabled.
ACOM	Analog common	4	D7 (D15)	Input for data bit 7 if enabling low byte (LB) latch or data bit 15 if enabling the high byte (HB) latch.
SJ (DAC705 and DAC707) lour (DAC706)	Summing junction of the internal output op amp for the DAC705 and DAC707, or the current output for the DAC706. Offset adjust circuit is connected to the summing junction of the output amplifier. Refer to Block Diagram.	5	D6 (D14)	Input for data bit 6 if enabling LB latch or data bit 14 if enabling the HB latch.
GA	Gain adjust pin. Refer to Connection Diagram for gain adjust circuit.	6	D5 (D13)	Data bit 5 (LB) or data bit 13 (HB)
+Vcc	Positive supply voltage (+15V)	7	D4 (D12)	Data bit 4 (LB) or data bit 12 (HB)
-V <sub>cc</sub>	Negative supply voltage (-15V)	. 8	D3 (D11)	Data bit 3 (LB) or data bit 11 (HB)
CLR	Clear line. Sets the input latch to zero and sets the D/A latch to the input code that gives bipolar zero on the	9	D2 (D10)	Data bit 2 (LB) or data bit 10 (HB)
	D/A output (Active low)			Date his 4 (I B) as data his 0 (HB)
WR	Write control line (Active low)	10	D1 (D9)	Data bit 1 (LB) or data bit 9 (HB)  Data bit 0 (LB) or data bit 8 (HB). Serial input when
A <sub>1</sub>	Enable for D/A converter latch (Active low)	11	D0 (D8)/SI	serial mode is selected.
Ao	Enable for input latch (Active low)	12	рсом	Digital common
D15 (MSB)	Data bit 15 (Most Significant Bit)	13	R <sub>f2</sub>	Feedback resistor for internal or external operational amplifier. Connect to pin 14 when a 10V output range is desired. Leave open for a 20V output range.
<b>D</b> 14	Data bit 14	14	Vout Ret (DAC708)	Voltage output for DAC709 or feedback resistor for use with an external output op amp for the DAC708. Refer to Connection Diagram for connection of external op amp to DAC708.
D13	Data bit 13	15	ACOM	Analog common
D12	Data bit 12	16	SJ (DAC709) lout (DAC708)	Summing junction of the internal output op amp for the DAC709, or the current output for the DAC708. Refer to Connection Diagram for connection of external op amp to DAC708.
D11	Data bit 11	17	ВРО	Bipolar offset. Connect to pin 16 when operating in the bipolar mode. Leave open for unipolar mode.
D10	Data bit 10	18	GA	Gain adjust pin
D9	Data bit 9	19	+Vcc	Positive supply voltage (+15V)
D8	Data bit 8	20	-Vcc	Negative supply voltage (-15V)
D7	Data bit 7	21	CLR	Clear line. Sets the high and low byte input registers to zero and, for bipolar operation, sets the D/A register to the input code that gives bipolar zero on the D/A output (In the unipolar mode, invert the MSB prior to the D/A.
D6	Data bit 6	22	WR :	Write control line
D5	Data bit 5	23	cs	Chip select control line
D4	Data bit 4	24	Voo	Logic supply (+5V)
D3	Data bit 3	25	No pin	
D2	Data bit 2	26	No pin	(The DAC708 and DAC709 are in 24-pin packages)
D1	Data bit 1	27	No pin	(THE STORES AND STATES AS NO III ET PIN PROBAGO)
DO (LSB)	Data bit 0 (Least Significant Bit)	28	No pin	1

#### **MECHANICAL**



#### **ABSOLUTE MAXIMUM RATINGS**

ł	•
V <sub>DO</sub> to COMMON         0V, ±15V           +V <sub>CE</sub> to COMMON         0V, ±16V           -V <sub>CE</sub> to COMMON         0V, −18V           Digital Data Inputs to COMMON         −0.5V, V <sub>DO</sub> ±0.5           DC Current any Input         ±10mA           Reference Out to COMMON         Indefinite Short to COMMON           Vour (DAC707, DAC709)         Indefinite Short to COMMON	External Voltage Applied to R <sub>F</sub> (pin 1, DAC706; pin 13 er 14, DAC708) ±18V External Voltage Applied to D/A Output (pin 1, DAC707; pin 14, DAC708) ±5V Power Dissipation

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DAC705/706/707, DAC708/709

## ORDERING INFORMATION

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		·	7
1	Temperature	Input	Output
Model	Range	Configuration	Configuration
DAC705KH	0°C to +70°C	16-bit port	±5V output
DAC705KH-BI	0°C to +70°C	16-bit port	±5V output
DAC705BH	-25°C to +85°C	16-bit port	±5V output
DAC705BH-BI	-25°C to +85°C	16-bit port	±5V output
DAC705BH/QM	-25°C to +85°C	16-bit port	±5V output
DAC705SH	-55°C to +125°C	16-bit port	±5V output
DAC705SH-BI	-55°C to +125°C	16-bit port	±5V output
DAC705SH/QM	-55°C to +125°C	16-bit port	±5V output
			<del></del>
DAC706KH	0°C to +70°C	16-bit port	±1mA output
DAC706KH-BI	0°C to +70°C	16-bit port	±1mA output
DAC706BH	-25°C to +85°C	16-bit port	±1mA output
DAC706BH-BI	-25°C to +85°C	16-bit port	±1mA output
DAC706BH/QM	-25°C to +85°C	16-bit port	±1mA output
DAC706SH	-55°C to +125°C	io-oit port	±1mA output
DAC706SH-BI	-55°C to +125°C	16-bit port	±1mA output
DAC706SH/QM	-55°C to +125°C	16-bit port	±1mA output
DAC707JP	0°C to +70°C	16-bit port	±10V output
DAC707JP-BI	0°C to +70°C	16-bit port	±10V output
DAC707KP	0°C to +70°C	16-bit port	±10V output
DAC707KP-BI	0°C to +70°C	16-bit port	±10V output
DAC707KH	0°C to +70°C	16-bit port	±10V output
DAC707KH-BI	0°C to +70°C	16-bit port	±10V output
DAC7078H	-25°C to +85°C	16-bit port	±10V output
DAC707BH-BI	25°C to +85°C	16-bit port	±10V output
DAC707BH/QM	-25°C to +85°C	16-bit port	±10V output
DAC707SH	-55°C to +125°C	16-bit port	±10V output
DAC707SH-BI	-55°C to +125°C	16-bit port	±10V output
DAC707SH/QM	-55°C to +125°C	16-bit port	±10V output
DAC708KH	0°C to +70°C	8-bit port	±1mA output
DAC708KH-BI	0°C to +70°C	8-bit port	±1mA output
DAC708BH	-25°C to +85°C	8-bit port	±1mA output
DAC708BH-BI	-25°C to +85°C	8-bit port	±1mA output
DAC708BH/QM	-25°C to +85°C	8-bit port	±1mA output
DAC708SH	-55°C to +125°C	8-bit port	±1mA output
DAC708SH-BI	-55°C to +125°C	8-bit port	±1mA output
DAC708SH/QM	-55°C to +125°C	8-bit port	±1mA output
DAC709KH	0°C to +70°C	8-bit port	±10V output
DAC709KH-BI	0°C to +70°C	8-bit port	±10V output
DAC709BH	-25°C to +85°C	8-bit port	±10V output
DAC709BH-BI	-25°C to +85°C	8-bit port	±10V output
DAC709BH/QM	-25°C to +85°C	8-bit port	±10V output
DAC709SH	-55°C to +125°C	8-bit port	±10V output
DAC709SH-BI	-55°C to +125°C	8-bit port	±10V output
DAC709SH/QM	-55°C to +125°C	8-bit port	±10V output

# DISCUSSION OF SPECIFICATIONS

#### **DIGITAL INPUT CODES**

For bipolar operation, the DAC705/706/707/708/709 accept positive-true binary two's complement input code. For unipolar operation (DAC708/709 only) the input code is positive-true straight-binary provided that the MSB input is inverted with an external inverter. See Table I.

TABLE I. Digital Input Codes.

	Analog Output							
Digital	Unipolar Straight Binary <sup>(1)</sup>	Binary Two's Complement						
Input	(DAC708/709 only; connec-	(Bipolar operation;						
Codes	ted for Unipolar operation)	all models)						
7FFH	+1/2 Full Scale —1 LSB <sup>12</sup>	∔Full Scale						
0000H	Zero	Zero						
FFFFH	+Full Scale	−1LSB						
8000H	+1/2 Full Scale	Full Scale						

(1) MSB must be inverted externally. (2) Assumes MSB is inverted externally.

#### **ACCURACY**

#### Linearity

This specification describes one of the most important measures of performance of a D/A converter. Linearity error is the deviation of the analog output from a straight line drawn through the end points (—Full Scale point and +Full Scale point).

#### **Differential Linearity Error**

Differential Linearity Error (DLE) of a D/A converter is the deviation from an ideal ILSB change in the output when the input changes from one adjacent code to the next. A differential linearity error specification of ±1/2LSB means that the output step size can be between 1/2LSB and 3/2LSB when the input changes between adjacent codes. A negative DLE specification of -1LSB maximum (-0.006% for 14-bit resolution) insures monotonicity.

#### Monotonicity

Monotonicity assures that the analog output will increase or remain the same for increasing input digital codes. The DAC705/706/707/708/709 are specified to be monotonic to 14 bits over the entire specification temperature range.

#### DRIFT

#### **Gain Drift**

Gain drift is a measure of the change in the full-scale range output over temperature expressed in parts per million per degree centigrade (ppm/°C). Gain drift is established by: (1) testing the end point differences at t<sub>min</sub>, +25°C and t<sub>max</sub>; (2) calculating the gain error with respect to the +25°C value; and (3) dividing by the temperature change.

#### Zero Drift

Zero drift is a measure of the change in the output with 0000<sub>H</sub> applied to the D/A converter inputs over the specified temperature range. (For the DAC708/709 in unipo-

lar mode, the MSB must be inverted.) This code corresponds to zero volts (DAC705/707 and DAC709) or zero milliamps (DAC706 and DAC708) at the analog output. The maximum change in offset at  $t_{min}$  or  $t_{max}$  is referenced to the zero error at  $\pm 25^{\circ}$ C and is divided by the temperature change. This drift is expressed in FSR/°C.

#### **SETTLING TIME**

Settling time of the D/A is the total time required for the analog output to settle within an error band around its final value after a change in digital input. Refer to Figure 1 for typical values for this family of products.

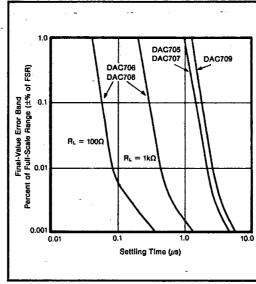


FIGURE 1. Final-Value Error Band Versus Full-Scale Range Settling Time.

#### **Voltage Output**

Settling times are specified to  $\pm 0.003\%$  of FSR ( $\pm 1/2$  LSB for 14 bits) for two input conditions: a full-scale range change of 20V ( $\pm 10$ V) or 10V ( $\pm 5$ V or 0 to 10V) and a 1LSB change at the "major carry", the point at which the worst-case settling time occurs. (This is the worst-case point since all of the input bits change when going from one code to the next.)

#### **Current Output**

Settling times are specified to  $\pm 0.003\%$  of FSR for a full-scale range change for two output load conditions: one for  $10\Omega$  to  $100\Omega$  and one for  $1000\Omega$ . It is specified this way because the output RC time constant becomes the dominant factor in determining settling time for large resistive loads.

#### **COMPLIANCE VOLTAGE**

Compliance voltage applies only to current output models. It is the maximum voltage swing allowed on the output current pin while still being able to maintain specified accuracy.

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#### **POWER SUPPLY SENSITIVITY**

Power supply sensitivity is a measure of the effect of a change in a power supply voltage on the D/A converter output. It is defined as a percent of FSR change in the output per percent of change in either the positive supply ( $+V_{cc}$ ), negative supply ( $-V_{cc}$ ) or logic supply ( $V_{DD}$ ) about the nominal power supply voltages (see Figure 2). It is specified for DC or low frequency changes. The typical performance curve in Figure 2 shows the effect of high frequency changes in power supply voltages.

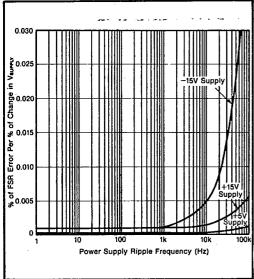


FIGURE 2. Power Supply Rejection Versus Power Supply Ripple Frequency.

## **OPERATING INSTRUCTIONS**

#### **POWER SUPPLY CONNECTIONS**

For optimum performance and noise rejection, power supply decoupling capacitors should be added as shown in the Connection Diagram.  $1\mu F$  tantalum capacitors should be located close to the D/A converter.

#### **EXTERNAL ZERO AND GAIN ADJUSTMENT**

Zero and gain may be trimmed by installing external zero and gain potentiometers. Connect these potentiometers as shown in the Connection Diagram and adjust as described below. TCR of the potentiometers should be 100ppm/°C or less. The 3.9M $\Omega$  and 270k $\Omega$  resistors ( $\pm 20\%$  carbon or better) should be located close to the D/A converter to prevent noise pickup. If it is not convenient to use these high-value resistors, an equivalent "T" network, as shown in Figure 3, may be substituted in place of the 3.9M $\Omega$  resistor. A 0.001 $\mu$ F to 0.01 $\mu$ F ceramic capacitor should be connected from GAIN ADJUST to ANALOG COMMON to prevent noise pickup. Refer to Figures 4 and 5 for the relationship of zero and gain adjustments to unipolar D/A converters.

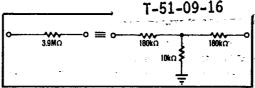


FIGURE 3. Equivalent Resistances.

#### Zero Adjustment

For unipolar (USB) configurations, apply the digital input code that produces zero voltage or zero current output and adjust the zero potentiometer for zero output:

For bipolar (BTC) configurations, apply the digital input code that produces zero output voltage or current. See Table II for corresponding codes and connection diagrams for zero adjustment circuit connections. Zero calibration should be made before gain calibration.

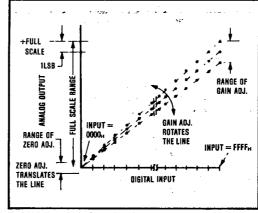


FIGURE 4. Relationship of Zero and Gain Adjustments for Unipolar D/A Converters, DAC708 and DAC709.

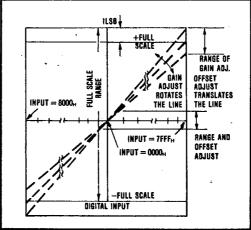


FIGURE 5. Relationship of Zero and Gain Adjustments for Bipolar D/A Converters, DAC705/706/707 and DAC708/709,

					VOLTAGE	OUTPUT I	MODELS					
Analog Output								Analog	Output			
Digital	·Un	lpolar, 0 to +	-10V	1	Digital Bipolar, ±10V Bipolar, ±		Bipolar, ±10V		Bipolar, ±5V			
Input Code	16-8lt	15-Bit	14-Bit	Units	Input inits Code	16-Bit	15-Bit	14-Bit	16-Bit	15-Bit	14-Bit .	Units
One LSB FFFF <sub>H</sub> 0000 <sub>H</sub>	153 +9.99985 0	305 +9.99969 0	610 +9.99939 0	μV V V	Опе LSB 7FFF <sub>H</sub> 8000 <sub>H</sub>	305 +9.99960 -10.0000	610 +9.99939 -10.0000	1224 +9.99878 -10.0000	153 +4.99980 -5.0000	305 +4.99970 -5.0000	610 +4.99939 -5.0000	μV V V
					CURREN	T OUTPUT	MODELS					

		Analog Output		81-11a)	Analog Output				
Digital	·Un	ipolar, 0 to -2	mA		Digital Input		Bipolar, ±tmA		
Input Code	16-BIt	15-Bit	14-Bit	Unite	Code	16-Bit	, 15-Bit	14-9it	Units
One LSB FFFF <sub>H</sub> 0000 <sub>H</sub>	0.031 -1.99997 0	0.061 -1.99994 0	0.122 -1.99988 0	μA mA mA	One LSB 7FFF <sub>H</sub> 8000 <sub>H</sub>	0.031 -0.99997 +1.00000	0.061 0.99994 +1.00000	0.122 -0.99988 +1.00000	μA mA mA

<sup>&#</sup>x27;MSB assumed to be inverted externally

#### **Gain Adjustment**

Apply the digital input that gives the maximum positive output voltage. Adjust the gain potentiometer for this positive full-scale voltage. See Table II for positive fullscale voltages and the Connection Diagrams for gain adjustment circuit connections.

#### INTERFACE LOGIC AND TIMING **DAC708/709**

The signals CHIP SELECT (CS), WRITE (WR), register enables  $(\overline{A_0}, \overline{A_i}, \text{ and } \overline{A_2})$  and CLEAR  $(\overline{CLR})$ , provide the control functions for the microprocessor interface. They are all active in the "low" or logic "0" state. CS must be low to access any of the registers.  $\overline{A_0}$  and  $\overline{A_1}$ steer the input 8-bit data byte to the low- or high-byte input latch respectively.  $\overline{A_2}$  gates the contents of the two input latches through to the D/A latch in parallel. The contents are then applied to the input of the D/A converter. When WR goes low, data is strobed into the latch or latches which have been enabled.

The serial input mode is activated when both  $\overline{A}_0$  and  $\overline{A}_1$ are logic "0" simultaneously. The D0 (D8)/SI input data line accepts the serial data MSB first. Each bit is clocked in by a  $\overline{WR}$  pulse. Data is strobed through to the D/Alatch by A2 going to logic "0" the same as in the parallel input mode.

Each of the latches can be made "transparent" by maintaining its enable signal at logic "0". However, as stated above, when both  $\overline{A_0}$  and  $\overline{A_1}$  are logic "0" at the same time, the serial mode is selected.

The CLR line resets both input latches to all zeros and sets the D/A latch to 0000<sub>H</sub>. This is the binary code that gives a null, or zero, at the output of the D/A in the bipolar mode. In the unipolar mode, activating CLR will cause the output to go to one-half of full scale.

The maximum clock rate of the latches is 10MHz. The minimum time between write (WR) pulses for successive enables is 20ns. In the serial input mode (DAC708 and DAC709), the maximum rate at which data can be clocked into the input shift register is 10MHz.

The timing of the control signals is given in Figure 6.

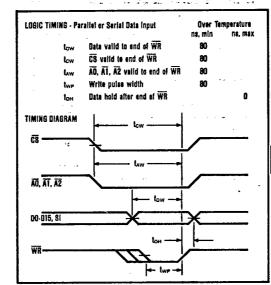


FIGURE 6. Logic Timing Diagram.

The DAC705/706/707 interface timing is the same as that described above except instead of two 8-bit separately-enabled input latches, it has a single 16-bit input latch enabled by  $\overline{A}_0$ . The D/A latch is enabled by  $\overline{A}_1$ . Also, there is no serial-input mode and no CHIP SELECT (CS) line.

## INSTALLATION CONSIDERATIONS

Due to the extremely-high accuracy of the D/A converter, system design problems such as grounding and contact resistance become very important. For a 16-bit converter with a +10V full-scale range, ILSB is 153 µV. With a load current of 5mA, series wiring and connector resistance of only  $30m\Omega$  will cause the output to be in error by ILSB. To understand what this means in terms **DAC705/706/707, DAC708/709** 

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**NSTRUMENTATION D/A CONVERTERS** 

of a system layout, the resistance of typical I ounce copper-clad printed circuit board material is approximately  $1/2m\Omega$  per square. In the example above, a 10 milliinch-wide conductor 60 milliinches long would cause a ILSB error.

In Figures 7 and 8, lead and contact resistances are represented by R1 through R5. As long as the load resistance R<sub>L</sub> is constant, R<sub>2</sub> simply introduces a gain error

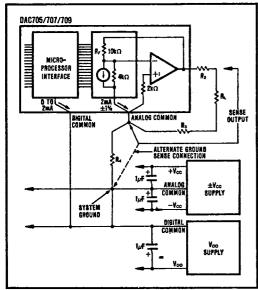


FIGURE 7. DAC705/707/709 Bipolar Output Circuit (Voltage Out).

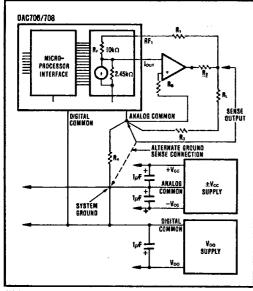


FIGURE 8. DAC706/708 Bipolar Output Circuit (with External Op Amp).

and can be removed with gain calibration. R3 is part of RL if the output voltage is sensed at ANALOG COM-

Figures 8 and 9 show two methods of connecting the current output model with an external precision output op amp. By sensing the output voltage at the load resistor (connecting R<sub>F</sub> to the output of the amplifier at R<sub>L</sub>) the effect of R1 and R2 is greatly reduced. R1 will cause a gain error but is independent of the value of RL and can be eliminated by initial calibration adjustments. The effect of R<sub>2</sub> is negligible because it is inside the feedback loop of the output op amp and is therefore greatly reduced by the loop gain.

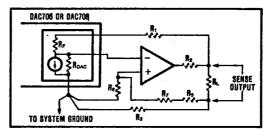


FIGURE 9. Alternate Connection for Ground Sensing at the Load (Current Output Models).

In many applications it is impractical to sense the output voltage at ANALOG COMMON. Sensing the output voltage at the system ground point is permissible because these converters have separate analog and digital common lines and the analog return current is a nearconstant 2mA and varies by only 10µA to 20µA over the entire input code range. R4 can be as large as 30 without adversely affecting the linearity of the D/A converter. The voltage drop across R4 is constant and appears as a zero error that can be nulled with the zero calibration adjustment.

Another approach senses the output at the load as shown in Figure 9. In this circuit the output voltage is sensed at the load common and not at the D/A converter common as in the previous circuits. The value of R6 and R<sub>7</sub> must be adjusted for maximum common-mode rejection across R<sub>L</sub>. The effect of R<sub>4</sub> is negligible as explained previously.

The D/A converter and the wiring to its connectors should be located to provide optimum isolation from sources of RFI and EMI. The key to elimination of RF radiation or pickup is small loop area. Signal leads and their return conductors should be kept close together such that they present a small flux-capture cross section for any external field.

#### **BURN-IN SCREENING**

Burn-in screening is an option available for the entire DAC705 through DAC709 family of products. Burn-in duration is 160 hours at the temperature shown below (or equivalent combination of time and temperature).

**Burn-In Screening** Model Temp. Range DAC705KH-BI 0°C to +70°C 160 hours at 85°C 160 hours at 85°C DAC705BH-BI -25°C to +85°C DAC705SH-BI -55°C to +125°C 160 hours at 125°C

All units are tested after burn-in to ensure that grade specifications are met. To order burn-in, add "-BI" to the base model.

#### **ENVIRONMENTAL SCREENING**

#### /QM Screening

All BH and SH models are available with Burr-Brown's /QM environmental screening for enhanced reliability. The screening, tabulated below, is performed to selected methods of MIL-STD-883. Reference to these methods provides a convenient method of communicating the screening levels and basic procedures employed; it does not imply conformance to any other military standards or to any methods of MIL-STD-883 other than those specified below. Burr-Brown's detailed procedures may vary slightly, model-to-model, from those in MIL-STD-883.

#### SCREENING FLOW FOR /QM MODELS

Screen	MIL-STD-883 Method	Candition	Comments
Internal Visual	2017	В	
High Temperature Storage (Stabili- zation Bake)	1008	С	+150°C, 24hrs
Temperature Cycling	1010	С	-65 to +150°C, 10 cycles
Burn-in	1015	В	+125°C, 160hrs
Constant Acceleration 28-pin pkg. 24-pin pkg.	2001	8 E	10,000G 30,000G
Hermeticity Fine Leak 28-pin pkg. 24-pin pkg. Gross Leak	1014	A1 or A2	2 × 10 <sup>-7</sup> atmcc/sec 5 × 10 <sup>-6</sup> atmcc/sec 60psig, 2hr
External Visual	2009		

#### APPLICATIONS

#### LOADING THE DAC709 SERIALLY ACROSS AN **ISOLATION BARRIER**

A very useful application of the DAC709 is in achieving low-cost isolation that preserves high accuracy. Using the serial input feature of the input register pair, only three signal lines need to be isolated. The data is applied to pin II in a serial bit stream, MSB first. The WR input

is used as a data strobe, clocking in each data bit. A RESET signal is provided for system startup and reset. These three signals are each optically isolated. Once the 16 bits of serial data have been strobed into the input register pair, the data is strobed through to the D/A register by the "carry" signal out of a 4-bit binary synchronous counter that has counted the 16 WR pulses used to clock in the data. The circuit diagram is given in Figure 10.

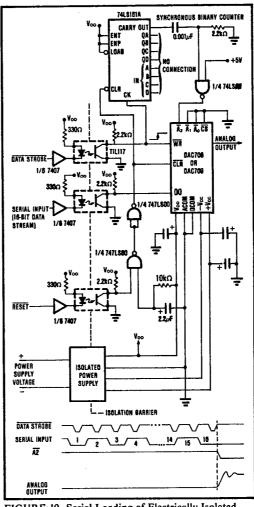


FIGURE 10. Serial Loading of Electrically Isolated DAC708/709.

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## CONNECTING MULTIPLE DAC707s TO A 16-BIT MICROPROCESSOR BUS

Figure 11 illustrates the method of connecting multiple DAC707s to a 16-bit microprocessor bus. The circuit shown has two DAC707s and uses only one address line to select either the input register or the D/A register. An external address decoder selects the desired converter.

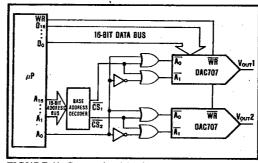


FIGURE 11. Connecting Multiple DAC707s to a 16-Bit Microprocessor.